

T-1 3/4 (5mm) INDICATOR LAMP WITH WIRE

Features

- Radial / Through hole package
- Reliable & robust
- Low power consumption
- ullet RoHS Compliant





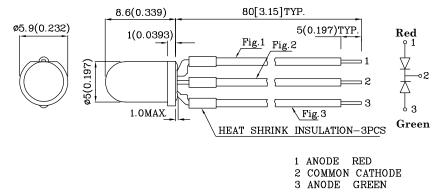


Jul 15,2017

ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES

Package Schematics

Fig.1 ANODE LEAD, TS , 22 AWG ,UL#1332 , ORANGE INSULATION,STRIP 5 mm . Fig.2 CATHODE LEAD, TS, 22 AWG, UL#1332, BROWN INSULATION, STRIP 5 mm. Fig.3 ANODE LEAD , TS , 22 AWG ,UL#1332 ,GREEN INSULATION ,STRIP 5 mm .



Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.25(0.01")$ unless otherwise noted.
- 3. Specifications are subject to change without notice.

Absolute Maximum Ratings (T _A =25°C)		Red (AlGaInP)	Green (InGaN)	Unit	
Reverse Voltage	V_{R}	5	5	V	
Forward Current	I_{F}	30	25	mA	
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	iFS	185	150	mA	
Power Dissipation		75	102.5	mW	
Electrostatic Discharge Threshold (HBM)		3000	450	V	
Operating Temperature	T_{A}	-40 ~	°C		
Storage Temperature	Tstg	-40 ~			
Lead Solder Temperature [2mm Below Package Base]	260°C For 3 Seconds				
Lead Solder Temperature [5mm Below Package Base]	260°C For 5 Seconds				

A Relative Humidity between 40% and 60% is recommended in ESD-protected work areas to reduce static build up during assembly process (Reference JEDEC/JESD625-A and JEDEC/J-STD-033)

Operating Characteristics $(T_A=25^{\circ}C)$	Red (AlGaInP)	Green (InGaN)	Unit	
Forward Voltage (Typ.) (I _F =20mA)	V_{F}	1.95	3.3	V
Forward Voltage (Max.) (I _F =20mA)	V_{F}	2.5	4.1	V
Reverse Current (Max.) $(V_R=5V)$	I_{R}	10	50	uA
Wavelength of Peak Emission CIE127-2007* (Typ.) (I _F =20mA)	λP	645*	515*	nm
Wavelength of Dominant Emission CIE127-2007* (Typ.) (I _F =20mA)	λD	630*	525*	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I _F =20mA)	Δλ	28	30	nm
Capacitance (Typ.) (V _F =0V, f=1MHz)	С	35	45	pF

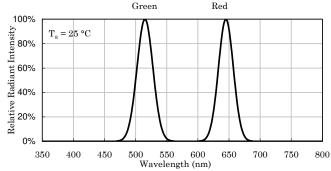
Luminous Intensity

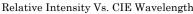
Part Number	Emitting Color	Emitting Material	Lens-color	$\begin{array}{c} \text{Luminous Intensity} \\ \text{CIE127-2007*} \\ \text{(I_F=20mA)} \\ \text{mcd} \end{array}$		Wavelength nm λP	Viewing Angle 20 1/2
				min.	typ.		
XLMDKDG59MW3.15	Red	AlGaInP	— White Diffused	600 80*	1195 198*	645*	- 30°
	Green	InGaN	- wnite Diffused	700 700*	1495 1495*	515*	

^{*}Luminous intensity value and wavelength are in accordance with CIE127-2007 standards.



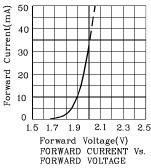


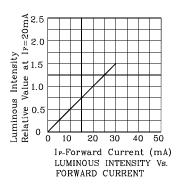


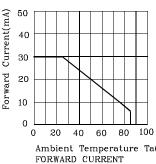


20° 10° 0° 50° 60 70 809 90 100 1.0 0.8 0.6 20° 40° 60° 80° 100° 120° 0.4 0° SPATIAL DISTRIBUTION

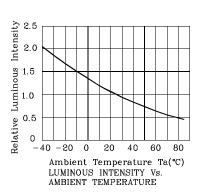
❖ Red



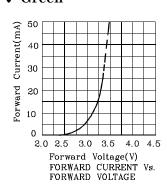


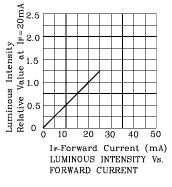


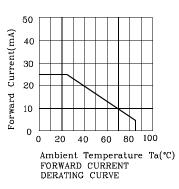
DERATING CURVE

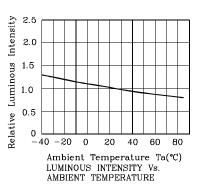


Green

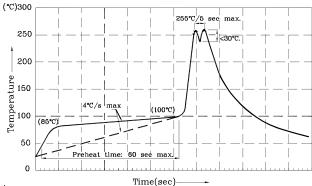








Wave Soldering Profile For Thru-Hole Products (Pb-Free Components)



- 1. Recommend pre-heat temperature of 105°C or less (as measured with a thermocouple attached to the LED pins) prior to immersion in the solder wave with a maximum solder bath temperature of 260°C 2. Peak wave soldering temperature between 245°C ~ 255°C for 3 sec
- (5 sec max).
- (8 sec links).

 3.Do not apply stress to the epoxy resin while the temperature is above 85°C.

 4.Fixtures should not incur stress on the component when mounting and during soldering process.

 5.SAC 305 solder alloy is recommended.

 6.No more than one wave soldering pass.

Remarks:

If special sorting is required (e.g. binning based on forward voltage, luminous intensity / luminous flux, or wavelength),

the typical accuracy of the sorting process is as follows:

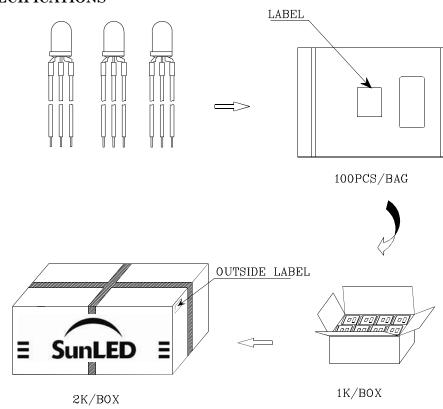
- 1. Wavelength: +/-1nm
- 2. Luminous Intensity / Luminous Flux: +/-15%
- 3. Forward Voltage: +/-0.1V

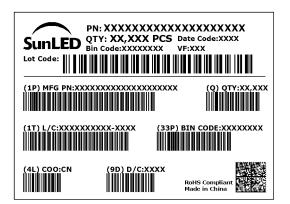
Note: Accuracy may depend on the sorting parameters.





PACKING & LABEL SPECIFICATIONS





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- 2. Contents within this document are subject to improvement and enhancement changes without notice.
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- $6. \ Additional\ technical\ notes\ are\ available\ at\ \underline{http://www.SunLEDusa.com/TechnicalNotes.asp}$

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